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Serial No.: 10/016,255

Confirmation No.: 7901

Filed: December 10, 2001

For: Barrier Layer for
Electroplating Processes

Examiner: McDonald, Rodney
Glenn

MAIL STOP NON-FEE AMENDMENT
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Sir:

37 CFR 1.8

I hereby certify that this correspondence is being deposited on **November 6, 2003** with the United States Postal Service as First Class Mail in an envelope addressed to: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

Nov. 6, 2003
Date

Eddy Sohn

RESPONSE TO OFFICE ACTION DATED AUGUST 6, 2003

In response to the Office Action dated August 6, 2003, having a shortened statutory period for response set to expire on November 6, 2003, please enter this response and reconsider the claims pending in the application for reasons discussed below. Although Applicant believes that no additional fees are due in connection with this response, the Commissioner is hereby authorized to charge counsel's Deposit Account No. 20-0782/APPM/2859.C1/EJS, for any fees, including extension of time fees or excess claim fees, required to make this response timely and acceptable to the Office.

Amendments to the Claims are reflected in the listing of claims which begins on page 2 of this paper. **Remarks/Arguments** begin on page 7 of this paper.